

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Vikas Wadhwa</td> <td>12/19/2012</td> </tr> <tr> <td>Jeroen Van Rotterdam</td> <td>12/19/2012</td> </tr> <tr> <td>Raman Walia</td> <td>12/19/2012</td> </tr> </tbody> </table>		Name	Execution Date	Vikas Wadhwa	12/19/2012	Jeroen Van Rotterdam	12/19/2012	Raman Walia	12/19/2012		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>EMC Corporation</td> </tr> <tr> <td>Street Address:</td> <td>176 South St</td> </tr> <tr> <td>City:</td> <td>Hopkinton</td> </tr> <tr> <td>State/Country:</td> <td>MASSACHUSETTS</td> </tr> <tr> <td>Postal Code:</td> <td>01748</td> </tr> </table>		Name:	EMC Corporation	Street Address:	176 South St	City:	Hopkinton	State/Country:	MASSACHUSETTS	Postal Code:	01748
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13725581</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13725581						
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CORRESPONDENCE DATA											
<p>Fax Number: 4089732595  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 408-973-2585</p> <p>Email: enguyen@ip-patent.com</p> <p>Correspondent Name: VAN PELT, YI &amp; JAMES LLP AND EMC CORPORA</p> <p>Address Line 1: 10050 N. FOOTHILL BLVD.</p> <p>Address Line 2: SUITE 200</p> <p>Address Line 4: CUPERTINO, CALIFORNIA 95014</p>											
ATTORNEY DOCKET NUMBER:	EMCCP314										
NAME OF SUBMITTER:	Jia-Ning Qu										
<p>Total Attachments: 4</p> <p>source=EMCCP314_Executed_Assignment#page1.tif</p> <p>source=EMCCP314_Executed_Assignment#page2.tif</p> <p>source=EMCCP314_Executed_Assignment#page3.tif</p> <p>source=EMCCP314_Executed_Assignment#page4.tif</p>											

CH \$40.00 13725581

ASSIGNMENT

WHEREAS, we, Vikas Wadhwa, Jeroen Van Rotterdam, and Raman Walia have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled *GENERATING CUSTOMIZED DOCUMENTATION FOR APPLICATIONS*, the specification of which:

☒ is being executed on even date herewith and is about to be filed in the United States Patent Office;

☐ was filed on \_\_\_\_\_ as U.S. Application No. \_\_\_\_\_;

☐ was patented under U.S. Patent No. \_\_\_\_\_ on \_\_\_\_\_.

WHEREAS, EMC Corporation (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including

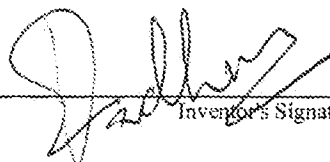
the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date:

19/Dec/2012



Inventor's Signature

Print full name of first inventor:

Vikas Wadhwa

Residence:

Bangalore, India

Citizenship:

India

Mailing Address:

176 South Street  
Hopkinton, MA 01748

I Rakesh Soma (name) whose residential address is 005, Kesthane Enclave, Shirdi Sai Nagar, Kundanbali was personally present and did see VIKAS WADHWA (name of person signing the assignment) who is personally known to me, execute the above assignment.

Soma Rakesh (signature of first witness)

Signed at Bangalore (location of witness signature)

on this day 19<sup>th</sup> Dec of 20 12 (date of signature)

I TEJAS. H. S. (name) whose residential address is #190/A, 44<sup>th</sup> CROSS, 8<sup>th</sup> BLOCK JAYANAGAR, BANGALORE-92 was personally present and did see VIKAS WADHWA (name of person signing the assignment) who is personally known to me, execute the above assignment.

Tejas H. S. (signature of second witness)

Signed at BANGALORE (location of witness signature)

on this day 19<sup>th</sup> December of 20 12 (date of signature)

Date:

Dec 19, 2012

[Signature]  
Inventor's Signature

Print full name of second inventor:

**Jeroen Van Rotterdam**

Residence:

Berkeley, CA

Citizenship:

United States of America

Mailing Address:

176 South Street

Hopkinton, MA 01748

STATE OF  
COUNTY OF

California  
Alameda

On this 19<sup>th</sup> day of December, 2012, before me appeared Jeroen Van Rotterdam who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official seal.

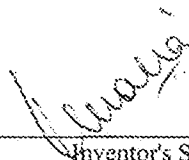


Donna Clark  
Notary Public

Print Name: Donna Clark

My Commission expires 2/18/13

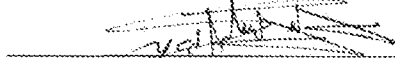
Date: 19<sup>th</sup> Dec 2012



Inventor's Signature

Print full name of third inventor: **Raman Wallia**  
Residence: **Bangalore, India**  
Citizenship: **India**  
Mailing Address: **176 South Street  
Hopkinton, MA 01748**

I Ashraf Ali Syed (name) whose residential address is  
68A, 9th main, BTM 2<sup>nd</sup> Stage Bangalore 560079 India was  
personally present and did see Raman Wallia (name of person signing the assignment)  
who is personally known to me, execute the above assignment.

 (signature of first witness)

Signed at Bangalore (location of witness signature)

on this day 19-12- of 20 12, (date of signature)

I Rakesh Soma (name) whose residential address is  
005, Keethana Enclave, Sherdt Sal Nagar, Kundanbali was  
personally present and did see RAMAN WALLIA (name of person signing the assignment)  
who is personally known to me, execute the above assignment.

Soma Rakesh (signature of second witness)

Signed at Bangalore (location of witness signature)

on this day 19<sup>th</sup> Dec of 20 12 (date of signature)